SN54AHCT123A, SN74AHCT123A DUAL RETRIGGERABLE MONOSTABLE MULTIVIBRATORS

SCLS420G - JUNE 1998 - REVISED APRIL 2003

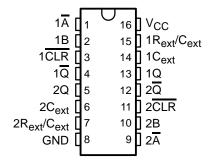
- Inputs Are TTL-Voltage Compatible
- Schmitt-Trigger Circuitry On A, B, and CLR Inputs for Slow Input Transition Rates
- Edge Triggered From Active-High or Active-Low Gated Logic Inputs
- Retriggerable for Very Long Output Pulses
- Overriding Clear Terminates Output Pulse
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

description/ordering information

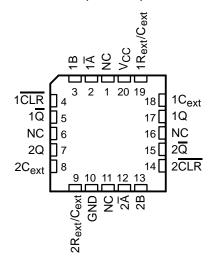
These edge-triggered multivibrators feature output pulse-duration control by three methods. In the first method, the \overline{A} input is low, and the B input goes high. In the second method, the B input is high, and the \overline{A} input goes low. In the third method, the \overline{A} input is low, the B input is high, and the clear (\overline{CLR}) input goes high.

The output pulse duration is programmed by selecting external resistance and capacitance values. The external timing capacitor must be connected between C_{ext} and $R_{\text{ext}}/C_{\text{ext}}$ (positive) and an external resistor connected between $R_{\text{ext}}/C_{\text{ext}}$ and V_{CC} . To obtain variable pulse durations, connect an external variable resistance between $R_{\text{ext}}/C_{\text{ext}}$ and V_{CC} . The output pulse duration also can be reduced by taking $\overline{\text{CLR}}$ low.

SN54AHCT123A . . . J OR W PACKAGE SN74AHCT123A . . . D, DB, DGV, N, OR PW PACKAGE (TOP VIEW)



SN54AHCT123A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

ORDERING INFORMATION

| TA | PACK | AGE† | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|---------------|--------------------------|---------------------|
| | PDIP – N | Tube | SN74AHCT123AN | SN74AHCT123AN |
| –40°C to 85°C | SOIC - D | Tube | SN74AHCT123AD | AHCT123A |
| | 30IC = D | Tape and reel | SN74AHCT123ADR | AUCTIZSA |
| -40 C to 65 C | SSOP – DB | Tape and reel | SN74AHCT123ADBR | HB123A |
| | TSSOP - PW | Tape and reel | SN74AHCT123APWR | HB123A |
| | TVSOP - DGV | Tape and reel | SN74AHCT123ADGVR | HB123A |
| | CDIP – J | Tube | SNJ54AHCT123AJ | SNJ54AHCT123AJ |
| –55°C to 125°C | CFP – W | Tube | SNJ54AHCT123AW | SNJ54AHCT123AW |
| | LCCC – FK | Tube | SNJ54AHCT123AFK | SNJ54AHCT123AFK |

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



SN54AHCT123A, SN74AHCT123A DUAL RETRIGGERABLE MONOSTABLE MULTIVIBRATORS

SCLS420G - JUNE 1998 - REVISED APRIL 2003

description/ordering information(continued)

Pulse triggering occurs at a particular voltage level and is not directly related to the transition time of the input pulse. The \overline{A} , B, and \overline{CLR} inputs have Schmitt triggers with sufficient hysteresis to handle slow input transition rates with jitter-free triggering at the outputs.

Once triggered, the basic pulse duration can be extended by retriggering the gated low-level-active (\overline{A}) or high-level-active (B) input. Pulse duration can be reduced by taking \overline{CLR} low. \overline{CLR} input can be used to override \overline{A} or B inputs. The input/output timing diagram illustrates pulse control by retriggering the inputs and early clearing.

The variance in output pulse duration from device to device typically is less than $\pm 0.5\%$ for given external timing components. An example of this distribution for the 'AHCT123A is shown in Figure 10. Variations in output pulse duration versus supply voltage and temperature are shown in Figure 6.

During power up, Q outputs are in the low state, and \overline{Q} outputs are in the high state. The outputs are glitch free, without applying a reset pulse.

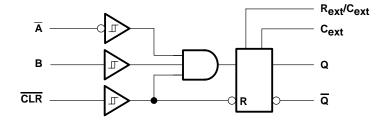
For additional application information on multivibrators, see the application report, *Designing With the SN74AHC123A and SN74AHCT123A*, literature number SCLA014.

FUNCTION TABLE (each multivibrator)

| ı | NPUTS | OUTPUTS | | | |
|------------|--------------|------------|----|----------------|--|
| CLR | Ā | В | q | Ø | |
| L | Χ | Х | L | Н | |
| Х | Н | X | ∟† | H [†] | |
| X | Χ | L | L† | H [†] | |
| Н | L | \uparrow | Л | Т | |
| Н | \downarrow | Н | Л | П | |
| \uparrow | L | Н | Л | T | |

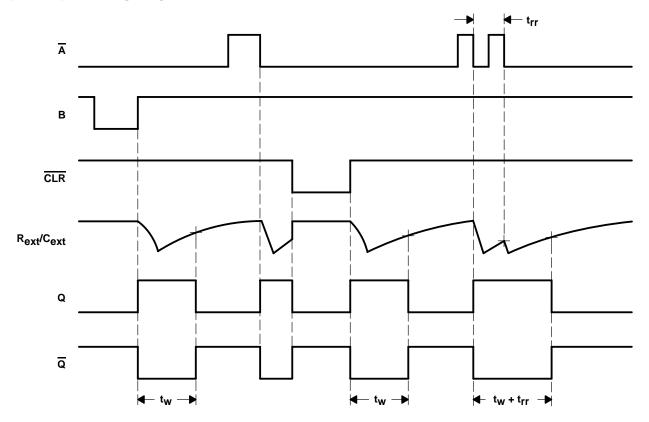
[†]These outputs are based on the assumption that the indicated steady-state conditions at the A and B inputs have been set up long enough to complete any pulse started before the setup.

logic diagram, each multivibrator (positive logic)





input/output timing diagram



absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

| Supply voltage range, V _{CC} (see Note 1) | –0.5 V to 7 V |
|---|---|
| Input voltage range, V _I (see Note 2) | –0.5 V to 7 V |
| Output voltage range, VO (see Note 1) | \dots –0.5 V to V _{CC} + 0.5 V |
| Input clamp current, I _{IK} (V _I < 0) | –20 mA |
| Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC}) | ±20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±25 mA |
| Continuous current through V _{CC} or GND | ±50 mA |
| Package thermal impedance, θ_{JA} (see Note 3): D package | 73°C/W |
| DB package | 82°C/W |
| DGV package | 120°C/W |
| N package | 67°C/W |
| PW package | 108°C/W |
| Storage temperature range, T _{Stg} | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values are with respect to the network ground terminal.

- 2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.



SN54AHCT123A, SN74AHCT123A **DUAL RETRIGGÉRABLE MONOSTABLE MULTIVIBRATORS**

SCLS420G - JUNE 1998 - REVISED APRIL 2003

recommended operating conditions (see Note 4)

| | | SN54AHC | T123A | SN74AH0 | T123A | UNIT |
|---------------------|--------------------------------|---------|-------|---------|-------|------|
| | | MIN | MAX | MIN | MAX | UNIT |
| Vcc | Supply voltage | 4.5 | 5.5 | 4.5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | 2 | | V |
| V _{IL} | Low-level input voltage | | 0.8 | | 0.8 | V |
| ٧ _I | Input voltage | 0 | 5.5 | 0 | 5.5 | V |
| ٧o | Output voltage | 0 | Vcc | 0 | Vcc | V |
| ЮН | High-level output current | | -8 | | -8 | mA |
| loL | Low-level output current | | 8 | | 8 | mA |
| R _{ext} | External timing resistance | 1k | | 1k | | Ω |
| Δt/ΔV _{CC} | Power-up ramp rate | 1 | | 1 | | ms/V |
| T _A | Operating free-air temperature | -55 | 125 | -40 | 85 | °C |

 $NOTE~4:~~Unused~R_{ext}/C_{ext}~terminals~should~be~left~unconnected.~All~remaining~unused~inputs~of~the~device~must~be~held~at~V_{CC}~or~GND~to~ensure~device~de$ proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DA | RAMETER | TEST CONDITIONS | Vaa | T, | _Δ = 25°(| 3 | SN54AHC | T123A | SN74AHC | T123A | UNIT |
|------|--------------------------------------|--|--------------|------|---------------------|-------|---------|-------|---------|-------|------|
| FA | RAMETER | TEST CONDITIONS | VCC | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| VOH | | I _{OH} = -50 μA | 4.5 V | 4.4 | 4.5 | | 4.4 | | 4.4 | | ٧ |
| VOH | | I _{OH} = -8 mA | | 3.94 | | | 3.8 | | 3.8 | | V |
| VOL | | I _{OL} = 50 μA | 4.5 V | | | 0.1 | | 0.1 | | 0.1 | V |
| VOL | _ | $I_{OL} = 8 \text{ mA}$ | 4.5 V | | | 0.36 | | 0.5 | | 0.44 | V |
| | R _{ext} /C _{ext} † | $V_I = V_{CC}$ or GND | 5.5 V | | | ±0.25 | | ±2.5 | | ±2.5 | |
| lį | A, B, and CLR | $V_I = V_{CC}$ or GND | 0 V to 5.5 V | | | ±0.1 | | ±1* | | ±1 | μΑ |
| ICC | Quiescent | $V_I = V_{CC}$ or GND, $I_O = 0$ | 5.5 V | | | 4 | | 40 | | 40 | μΑ |
| ICC | Active state (per circuit) | $V_I = V_{CC}$ or GND, $R_{ext}/C_{ext} = 0.5 V_{CC}$ | 5.5 V | | 560 | 750 | | 975 | | 975 | μΑ |
| ∆lcc | ‡ | One input at 3.4 V, Other inputs at V _{CC} or GND | 5.5 V | | | 1.35 | | 1.5 | | 1.5 | mA |
| Ci | | $V_I = V_{CC}$ or GND | 5 V | | 1.9 | 10 | | | | 10 | pF |

 $[\]star$ On products compliant to MIL-PRF-38535, this parameter is not production tested at $V_{CC} = 0 \text{ V}$.

timing requirements over recommended operating free-air temperature range, $V_{\mbox{CC}}$ = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

| | | | TEST CONDITIONS | T _A = 25°C | | | SN54AHC | T123A | SN74AHCT123A | | UNIT |
|----------------|------------|----------------|---|-----------------------|-----|-----|---------|-------|--------------|-----|------|
| | | | TEST CONDITIONS | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | Pulse | CLR | | 5 | | | 5 | | 5 | | ns |
| t _W | duration | A or B trigger | | 5 | | | 5 | | 5 | | 115 |
| · | Dulaa sats | : | $R_{ext} = 1 k\Omega$, $C_{ext} = 100 pF$ | 8 | 60 | | § | | § | | ns |
| trr | Pulse retr | igger time | $R_{ext} = 1 \text{ k}\Omega, C_{ext} = 0.01 \mu\text{F}$ | § | 1.5 | | § | | § | | μs |

[§] See retriggering data in the application information section.



[†] This test is performed with the terminal in the off-state condition.

 $^{^{\}ddagger}$ This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or V $_{
m CC}$.

SN54AHCT123A, SN74AHCT123A **DUAL RETRIGGERABLE MONOSTABLE MULTIVIBRATORS**

SCLS420G - JUNE 1998 - REVISED APRIL 2003

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

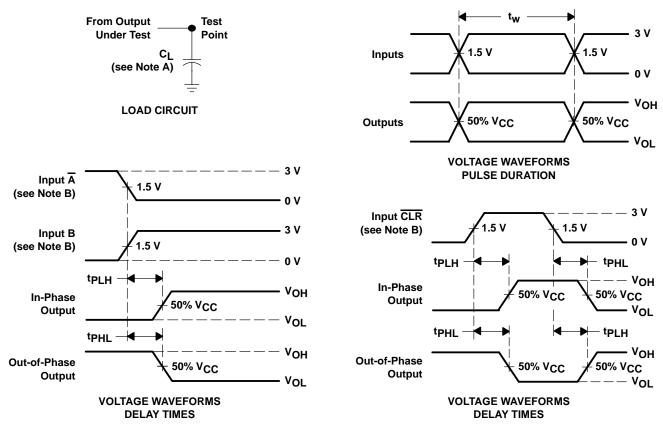
| | FROM | то | TEST | T, | λ = 25°C | ; | SN54AHC | T123A | SN74AHC | T123A | |
|-------------------|-------------|---------------------|---|-----|----------|-----|---------|-------|---------|-------|------|
| PARAMETER | (INPUT) | (OUTPUT) | CONDITIONS | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| tPLH | | 0 0 | C: -15 pE | | 5.3* | 10* | 1* | 13* | 1 | 11 | ns |
| tPHL | A or B | Q or Q | C _L = 15 pF | | 5.3* | 10* | 1* | 13* | 1 | 11 | ns |
| t _{PLH} | CLR | 0 0 | C _L = 15 pF | | 7.7* | 12* | 1* | 15* | 1 | 13 | ns |
| tPHL | CLR | Q or Q | CL = 15 pr | | 7.7* | 12* | 1* | 15* | 1 | 13 | 115 |
| t _{PLH} | <u> </u> | 0 0 | C: -15 pE | | 8* | 13* | 1* | 16* | 1 | 14 | ns |
| tPHL | CLR trigger | Q or Q | C _L = 15 pF | | 8* | 13* | 1* | 16* | 1 | 14 | 115 |
| tPLH | D | 0 | C: - 50 pE | | 6.8 | 11 | 1 | 14 | 1 | 12 | 20 |
| tPHL | A or B | Q or Q | C _L = 50 pF | | 6.8 | 11 | 1 | 14 | 1 | 12 | ns |
| t _{PLH} | | | C: - 50 pF | | 9.2 | 13 | 1 | 16 | 1 | 14 | ns |
| t _{PHL} | CLR | Q or Q | $C_L = 50 pF$ | | 9.2 | 13 | 1 | 16 | 1 | 14 | 115 |
| t _{PLH} | <u> </u> | 0 | C: - 50 pF | | 9.5 | 14 | 1 | 17 | 1 | 15 | ns |
| t _{PHL} | CLR trigger | Q or Q | C _L = 50 pF | | 9.5 | 14 | 1 | 17 | 1 | 15 | 115 |
| | | | $C_L = 50 \text{ pF},$ $C_{ext} = 28 \text{ pF},$ $R_{ext} = 2 \text{ k}\Omega$ | | 133 | 200 | | 240 | | 240 | ns |
| _{tw} † | | Q or \overline{Q} | $C_L = 50 \text{ pF},$ $C_{ext} = 0.01 \mu\text{F},$ $R_{ext} = 10 k\Omega$ | 90 | 100 | 110 | 90 | 110 | 90 | 110 | μs |
| | | | C_L = 50 pF, C_{ext} = 0.1 μ F, R_{ext} = 10 k Ω | 0.9 | 1 | 1.1 | 0.9 | 1.1 | 0.9 | 1.1 | ms |
| Δt _W ‡ | | | | | ±1 | | | | | | % |

operating characteristics, V_{CC} = 5 V, T_A = 25°C

| | PARAMETER | TEST CONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|-----------------|-----|------|
| C _{pd} | Power dissipation capacitance | No load | 29 | pF |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.
† t_W = Pulse duration at Q and \overline{Q} outputs
‡ Δt_W = Output pulse-duration variation (Q and \overline{Q}) between circuits in same package

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: $Z_0 = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

SCLS420G - JUNE 1998 - REVISED APRIL 2003

APPLICATION INFORMATION

caution in use

To prevent malfunctions due to noise, connect a high-frequency capacitor between V_{CC} and GND, and keep the wiring between the external components and C_{ext} and R_{ext}/C_{ext} terminals as short as possible.

power-down considerations

Large values of C_{ext} may cause problems when powering down the 'AHCT123A devices because of the amount of energy stored in the capacitor. When a system containing this device is powered down, the capacitor may discharge from V_{CC} through the protection diodes at pin 2 or pin 14. Current through the input protection diodes must be limited to 30 mA; therefore, the turn-off time of the V_{CC} power supply must not be faster than $t = V_{CC} \times C_{ext}/30$ mA. For example, if $V_{CC} = 5$ V and $V_{CC} = 15$ PF, the V_{CC} supply must turn off no faster than $V_{CC} = 15$ V and $V_{CC} = 15$ V and $V_{CC} = 15$ PF, the $V_{CC} = 15$ PF, the V

output pulse duration

The output pulse duration, t_W , is determined primarily by the values of the external capacitance (C_T) and timing resistance (R_T). The timing components are connected as shown in Figure 2.

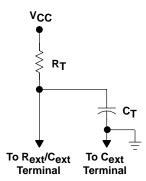


Figure 2. Timing-Component Connections

The pulse duration is given by:

$$t_w = K \times R_T \times C_T$$
 if C_T is \geq 1000 pF, K = 1.0 or if C_T is $<$ 1000 pF, K can be determined from Figure 5

where:

t_w = pulse duration in ns

 R_T = external timing resistance in $k\Omega$

C_T = external capacitance in pF

K = multiplier factor

Equation 1 and Figure 3 can be used to determine values for pulse duration, external resistance, and external capacitance.

SCLS420G - JUNE 1998 - REVISED APRIL 2003

APPLICATION INFORMATION

retriggering data

The minimum input retriggering time (t_{MIR}) is the minimum time required after the initial signal before retriggering the input. After t_{MIR} , the device retriggers the output. Experimentally, it also can be shown that to retrigger the output pulse, the two adjacent input signals should be t_{MIR} apart, where $t_{MIR} = 0.30 \times t_{w}$. The retrigger pulse duration is calculated as shown in Figure 3.

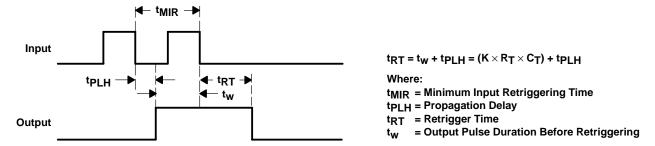
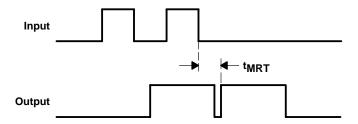


Figure 3. Retrigger Pulse Duration

The minimum value from the end of the input pulse to the beginning of the retriggered output should be approximately 15 ns to ensure a retriggered output (see Figure 4).



 $t_{\mbox{MRT}}$ = Minimum Time Between the End of the Second Input Pulse and the Beginning of the Retriggered Output $t_{\mbox{MRT}}$ = 15 ns

Figure 4. Input/Output Requirements



APPLICATION INFORMATION[†]

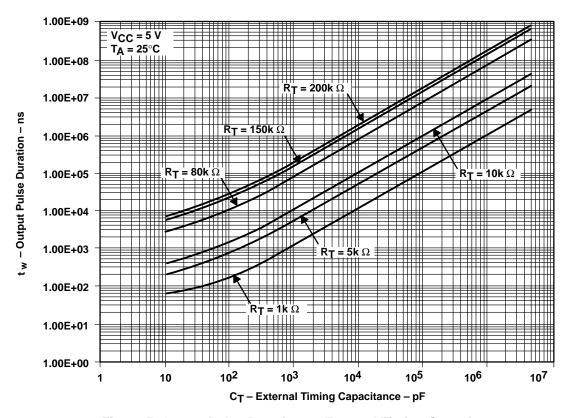


Figure 5. Output Pulse Duration vs External Timing Capacitance

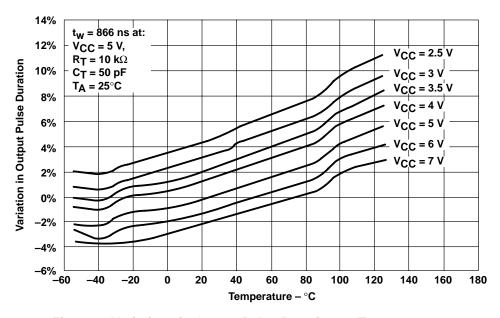
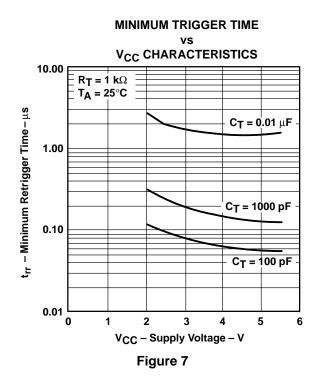


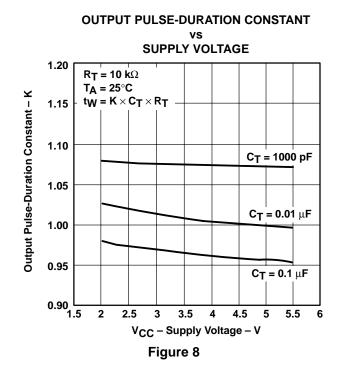
Figure 6. Variations in Output Pulse Duration vs Temperature

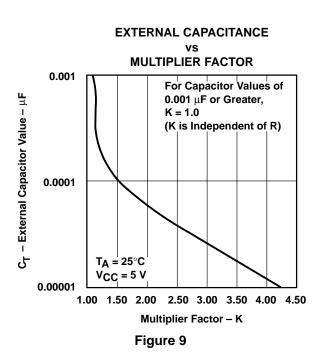
[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.

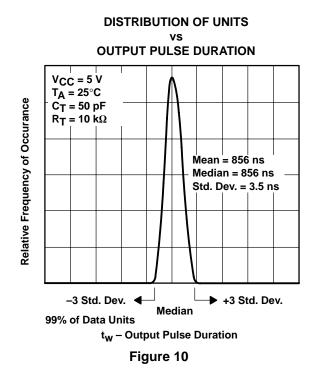


APPLICATION INFORMATION[†]









[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.



27-Aug-2024 www.ti.com

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|------------|--------------|--------------------|------|----------------|---------------------|-------------------------------|--------------------|--------------|--|---------|
| 5962-9861601Q2A | ACTIVE | LCCC | FK | 20 | 55 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962- 9861601Q2A SNJ54AHCT 123AFK | Samples |
| 5962-9861601QEA | ACTIVE | CDIP | J | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9861601QE A SNJ54AHCT123AJ | Samples |
| 5962-9861601QFA | ACTIVE | CFP | W | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9861601QF A SNJ54AHCT123AW | Samples |
| SN74AHCT123AD | OBSOLETE | SOIC | D | 16 | | TBD | Call TI | Call TI | -40 to 85 | AHCT123A | |
| SN74AHCT123ADBR | ACTIVE | SSOP | DB | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | HB123A | Samples |
| SN74AHCT123ADGVR | ACTIVE | TVSOP | DGV | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | HB123A | Samples |
| SN74AHCT123ADR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AHCT123A | Samples |
| SN74AHCT123AN | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -40 to 85 | SN74AHCT123AN | Samples |
| SN74AHCT123APWR | ACTIVE | TSSOP | PW | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | HB123A | Samples |
| SNJ54AHCT123AFK | ACTIVE | LCCC | FK | 20 | 55 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962- 9861601Q2A SNJ54AHCT 123AFK | Samples |
| SNJ54AHCT123AJ | ACTIVE | CDIP | J | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9861601QE A SNJ54AHCT123AJ | Samples |
| SNJ54AHCT123AW | ACTIVE | CFP | W | 16 | 25 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | 5962-9861601QF A SNJ54AHCT123AW | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.



www.ti.com 27-Aug-2024

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54AHCT123A, SN74AHCT123A:

Catalog: SN74AHCT123A

Military: SN54AHCT123A

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 5-Dec-2023

TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74AHCT123ADBR | SSOP | DB | 16 | 2000 | 330.0 | 16.4 | 8.35 | 6.6 | 2.4 | 12.0 | 16.0 | Q1 |
| SN74AHCT123ADGVR | TVSOP | DGV | 16 | 2000 | 330.0 | 12.4 | 6.8 | 4.0 | 1.6 | 8.0 | 12.0 | Q1 |
| SN74AHCT123ADR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74AHCT123APWR | TSSOP | PW | 16 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |

www.ti.com 5-Dec-2023



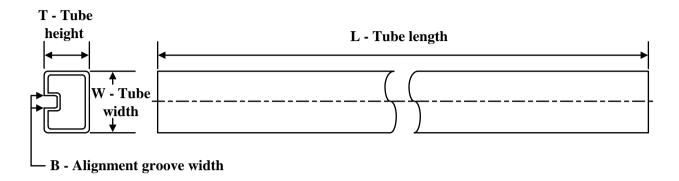
*All dimensions are nominal

| 7 til dilliololololo di o liolililai | | | | | | | |
|--------------------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| SN74AHCT123ADBR | SSOP | DB | 16 | 2000 | 356.0 | 356.0 | 35.0 |
| SN74AHCT123ADGVR | TVSOP | DGV | 16 | 2000 | 356.0 | 356.0 | 35.0 |
| SN74AHCT123ADR | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 |
| SN74AHCT123APWR | TSSOP | PW | 16 | 2000 | 356.0 | 356.0 | 35.0 |

PACKAGE MATERIALS INFORMATION

www.ti.com 5-Dec-2023

TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-9861601Q2A | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| 5962-9861601QFA | W | CFP | 16 | 25 | 506.98 | 26.16 | 6220 | NA |
| SN74AHCT123AN | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SNJ54AHCT123AFK | FK | LCCC | 20 | 55 | 506.98 | 12.06 | 2030 | NA |
| SNJ54AHCT123AW | W | CFP | 16 | 25 | 506.98 | 26.16 | 6220 | NA |

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.







- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
 4. Reference JEDEC registration MO-150.





NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2024, Texas Instruments Incorporated